

# NOT RECOMMENDED FOR NEW DESIGN USE DMP3068L



DMP3130L

#### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> T <sub>A</sub> = +25°C
	$77m\Omega@V_{GS} = -10V$	-3.5A
-30V	$95m\Omega@V_{GS} = -4.5V$	-3.0A
	$150 \text{m} \Omega @ V_{GS} = -2.5 \text{V}$	-2.4A

### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMP3130LQ)

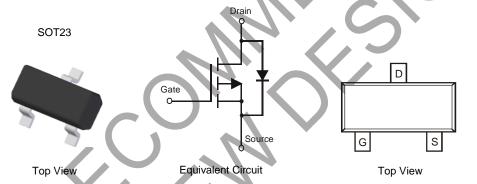
### **Description and Applications**

This new generation MOSFET has been designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Analog Switch

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)



### Ordering Information (Note 4)

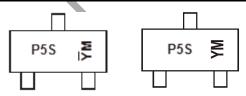
Part Number	Case	Packaging
DMP3130L-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Shanghai A/T Site

# **Marking Information**



Chengdu A/T Site

P5S = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test Site)

YM = Date Code Marking for CAT (Chengdu Assembly/ Test Site)

Y or  $\overline{Y}$  = Year (ex: E = 2017)

M = Month (ex: 9 = September)

Date Code Key

Year	2008	2009	2010	2011	2012	20	13	2014	2015	2016	2017	2018
Code	V	W	Х	Υ	Z	A	Ą	В	С	D	Е	F
Month	Jan	Feb	Mar	Apr	May	Jun	Ju	l Aug	ј Ѕер	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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**DMP3130L** 

# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		$V_{DSS}$	-30	V	
Gate-Source Voltage		$V_{GSS}$	±12	V	
Continuous Drain Current (Note 5) // 45/	l <sub>D</sub>	-3.0 -2.6	А		
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-4.1 -3.2	А
Maximum Continuous Body Diode Forward Current	(Note 5)	Is	-1.6	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	)	I <sub>DM</sub>	-20	А	

## **Thermal Characteristics**

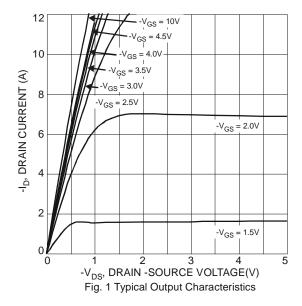
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P <sub>D</sub>	0.7	W
Total I owel Dissipation (Note 3)	$T_A = +70^{\circ}C$	FD	0.4	VV
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	184	°CW
Themai Resistance, Junction to Ambient (Note 3)	t<10s	$\kappa_{ heta}$ JA	115	C/VV
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	Pn	1.3	W
Total Fower Dissipation (Note 0)	T <sub>A</sub> = +70°C	PD	0.8	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	94	
Themai Resistance, Junction to Ambient (Note 0)	t<10s	$R_{\theta JA}$	61	°C/W
Thermal Resistance, Junction to Case		$R_{ heta JC}$	25	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

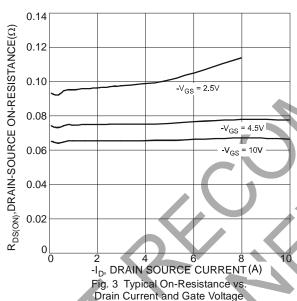
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	4		V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	7-1	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Body Leakage	I <sub>GSS</sub>		1-7	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(TH)}$	-0.6		-1.3	V	$V_{DS} = V_{GS}, I_{D} = -250\mu A$	
			59	77		$V_{GS} = -10V, I_D = -4.2A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		73	95	mΩ	$V_{GS} = -4.5V$ , $I_D = -4A$	
		1	115	150		$V_{GS} = -2.5V, I_D = -3A$	
Forward Transconductance	<b>g</b> fs		8		S	$V_{DS} = -5V, I_{D} = -4A$	
Source-Drain Diode Forward Voltage	$V_{SD}$		-0.8	-1.25	V	$V_{GS} = 0V, I_{S} = -3.0A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		432	864	pF	V 45V V 0V	
Output Capacitance	Coss		87	174	pF	$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	$C_{rss}$		62	124	pF	1 - 1.01VII 12	
Gate Resistance	R <sub>G</sub>		4.04		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
SWITCHING CHARACTERISTICS (Note 8)							
Total Gate Charge	$Q_{\mathrm{G}}$		5.9	11.8		$V_{DS} = -15V$ , $V_{GS} = -4.5V$ , $I_{D} = -4.0A$	
Total Gate Gharge	વહ	_	12	24	nC	$V_{DS} = -15V$ , $V_{GS} = -10V$ , $I_{D} = -4.0A$	
Gate-Source Charge	$Q_GS$		1.0	2.0	110	Vns = -15V, Vgs = -4.5V, In = -4.0A	
Gate-Drain Charge	$Q_GD$		3.1	6.2		VDS = -15V, $VGS = -4.5V$ , $ID = -4.0A$	
Turn-On Delay Time	t <sub>D(ON)</sub>		4.6	9.2			
Rise Time	t <sub>R</sub>		6.5	13.0	ns	$V_{DS} = -15V$ , $V_{GS} = -10V$ ,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>		27.8	55.6	115	$I_D = -1A, R_G = 6.0\Omega$	
Fall Time	t <sub>F</sub>	_	15.0	30.0			

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
  6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to production testing.





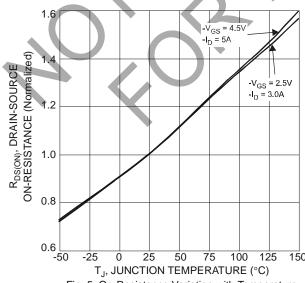
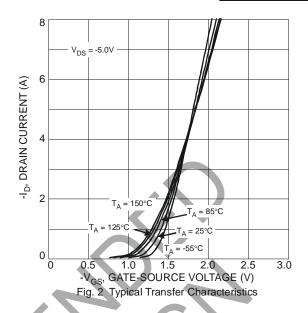
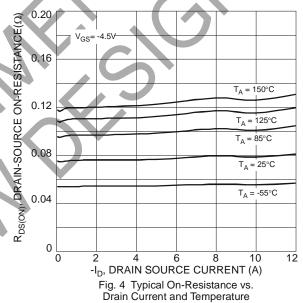


Fig. 5 On-Resistance Variation with Temperature





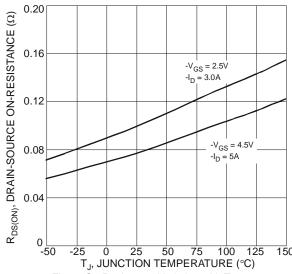


Fig. 6 On-Resistance Variation with Temperature



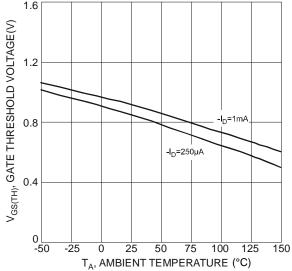
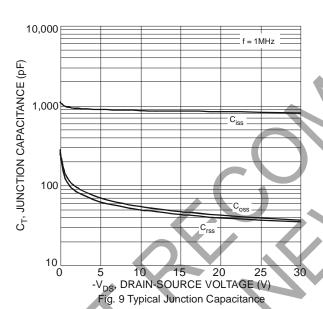
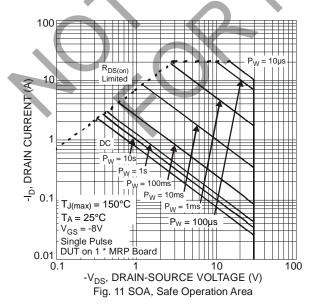
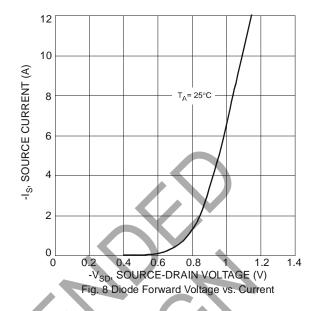
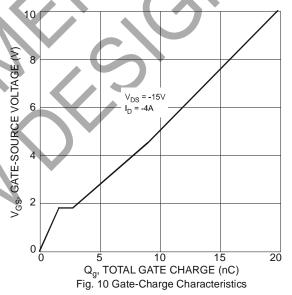


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

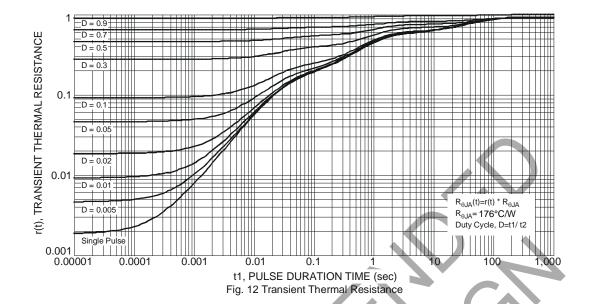










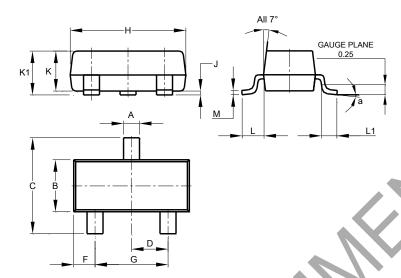




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23

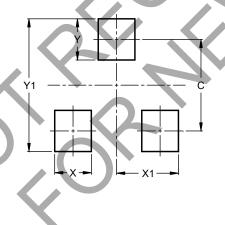


SOT23							
Dim	Min	Max	Тур				
A	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Η	2.80	3.00	2.90				
7	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
M	0.085	0.150	0.110				
а	0°	8°					
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
C	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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**DMP3130L** 

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